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By: Markus Nolf Date: October 7, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 09/804,323 Confirmation No: 1014
Applicant : Horst Belau, et al.
Filed : March 12, 2001
Art Unit : 2827
Examiner : Jeremy C. Norris

Docket No. : GR 98 P 2544 P
Customer No. : 24131

CLAIM FOR PRIORITY

Commissioner for Patents,
P.O. Box 1450, Alexandria, VA 22313-1450

Sir:

Claim is hereby made for a right of priority under Title 35, U.S. Code, Section 119, based upon the German Patent Application 198 41 459.5, filed September 10, 1998.

A certified copy of the above-mentioned foreign patent application is being submitted herewith.

Respectfully submitted,

Markus Nolf
For Applicant

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Date: October 7, 2003

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BUNDESREPUBLIK DEUTSCHLAND



Prioritätsbescheinigung über die Einreichung einer Patentanmeldung

Aktenzeichen: 198 41 459.5

Anmeldetag: 10. September 1998

Anmelder/Inhaber: Siemens Aktiengesellschaft, München/DE

Bezeichnung: Leiterplattenanordnung mit mehrpoligem Steckverbinder

IPC: H 05 K und H 01 R

Die Akte dieser Patentanmeldung ist ohne vorherige Offenlegung vernichtet worden.

München, den 22. September 2003
Deutsches Patent- und Markenamt
Der Präsident
Im Auftrag

A handwritten signature in black ink, appearing to read 'R. aig'.

A small, rectangular official stamp or seal, partially obscured by the signature.